



RoHS Status of Frequency Control Products

Soldering Guidelines

In July 2006 the European Union (EU) directive "Restriction of Hazardous Substances" (RoHS) was implemented which defined specific substances that must be eliminated from electronic components. The six hazardous substances are: lead, cadmium, mercury, hexavalent chromium, polybrominated biphenyl (PBB) and polybrominated diphenyl ether (PBDE) flame retardants. The main issue affecting manufacture of electronic components and associated assemblies is the restriction of lead in solder.

Reflow Soldering

The solder industry has worked on the composition and development of RoHS compliant solders based on for example alloys of Sn/Ag/ Cu and various types are available with different melting points and characteristics. In general RoHS compliant solders require a higher maximum reflow temperature compared with traditional lead based solders. As such the market place has moved towards a common maximum soldering temperature for RoHS compliant components of up to 260°C, even though in many instances this temperature may never be reached and better results may be obtained by using lower temperatures of for example 245°C maximum. Due to the varied nature and product mix of PCB assemblies and the component types used, we recommend that customers experiment with device samples from IQD and develop their own soldering profiles to suit their specific product needs. The JEDEC standard J-STD-020 has suggestions on reflow profiles for both solders with lead and for RoHS compliant solders. Almost all the frequency product types supplied by IQD are RoHS compliant as standard and as such the majority of SMD devices can be reflow soldered at up to 260°C maximum. For individual device details concerning soldering temperature levels, please see below Note: - current IQD part numbers have the prefix "LF" to denote RoHS compliance. Part numbers that are supplied as non RoHS compliant will be prefixed with "F1".

| Product Range | RoHS Status | Part No. Status | Termination when compliant | Maximum reflow temperature and time |
|-----------------|-------------|-----------------|----------------------------|-------------------------------------|
| AXTAL(Q) | | | | |
| 12SMX AUTO | Compliant | LF prefix | NiAu | 260°C max for 10secs max |
| HC49/4HSMX AUTO | Compliant | LF prefix | SnAgCu | 260degC 10s |
| IQXC-104 AUTO | Compliant | LF prefix | NiAu | 260°C max for 10secs max |
| IQXC-180 AUTO | Compliant | LF prefix | NiAu | 260°C max for 10secs max |
| IQXC-228 AUTO | Compliant | LF prefix | NiAu | 260degC 10s |
| MEMS | | | | |
| IQMS-133 | Compliant | LF prefix | NiPdAu | 260°C max for 40secs max |
| IQMS-134 | Compliant | LF prefix | NiPdAu | 260°C max for 40secs max |
| IQMS-135 | Compliant | LF prefix | NiPdAu | 260°C max for 40secs max |
| IQMS-136 | Compliant | LF prefix | NiPdAu | 260°C max for 40secs max |
| IQMS-137 | Compliant | LF prefix | NiPdAu | 260°C max for 40secs max |
| IQMS-138 | Compliant | LF prefix | NiPdAu | 260°C max for 40secs max |
| IQMS-144 | Compliant | LF prefix | NiPdAu | 260°C max |
| IQMS-145 | Compliant | LF prefix | NiPdAu | 260°C max |
| IQMS-146 | Compliant | LF prefix | NiPdAu | 260°C max |
| IQMS-147 | Compliant | LF prefix | NiPdAu | 260°C max |
| OCXO | | | | |

Note: Temperatures and times given are for guidance. Due to the many variations in solder processing, assessment within the customer's application will be required to establish the correct process parameters.

| Product Range | RoHS Status | Part No. Status | Termination when compliant | Maximum reflow temperature and time |
|---------------|-------------|-----------------|--|-------------------------------------|
| IQOV-71 | Compliant | LF prefix | Au over Ni | 250°C max for 30secs max |
| PXO | | | | |
| CFPP-131 | Compliant | LF prefix | Matte Sn | 260degC 10s |
| CFPP-149 | Compliant | LF prefix | Matte Sn | 260degC 10s |
| CFPP-23 | Compliant | LF prefix | Matte Sn | 260degC 10s |
| CFPP-303 | Compliant | LF prefix | Matte Sn | 260degC 10s |
| CFPP-307 | Compliant | LF prefix | Matte Sn | 260degC 10s |
| CFPP-39 | Compliant | LF prefix | NiAu | 260degC 10s |
| CFPP-40 | Compliant | LF prefix | NiAu | 260degC 10s |
| CFPP-41 | Compliant | LF prefix | NiAu | 260degC 10s |
| CFPP-57 | Compliant | LF prefix | Matte Sn | 260degC 10s |
| PTXO | | | | |
| CFPT-9001 | Compliant | LF prefix | NiCoAu | 260degC 30s |
| CFPT-9003 | Compliant | LF prefix | NiCoAu | 260degC 30s |
| CFPT-9005 | Compliant | LF prefix | NiCoAu | 260degC 30s |
| CFPT-9006 | Compliant | LF prefix | NiCoAu | 260degC 30s |
| CFPT-9007 | Compliant | LF prefix | NiCoAu | 260degC 30s |
| CFPT-9008 | Compliant | LF prefix | NiCoAu | 260degC 30s |
| E2747 | Compliant | LF prefix | NiCoAu | 260degC 30s |
| E2791 | Compliant | LF prefix | NiCoAu | 260degC 30s |
| E2799 | Compliant | LF prefix | NiCoAu | 260degC 30s |
| E3179LF | Compliant | LF prefix | NiCoAu | 260degC 30s |
| E3198 | Compliant | LF prefix | NiCoAu | 260degC 30s |
| E3199LF | Compliant | LF prefix | NiCoAu | 260degC 30s |
| RBXO | | | | |
| IQRB-1 | Compliant | LF prefix | Pin material is Kovar with Au plating. | |
| SPXO | | | | |
| CFPS-107 | Compliant | LF prefix | NiAu | 260degC 10s |
| CFPS-108 | Compliant | LF prefix | NiAu | 260degC 10s |
| CFPS-109 | Compliant | LF prefix | NiAu | 260degC 10s |
| CFPS-12 | Compliant | LF prefix | NiAu | 260degC 10s |
| CFPS-302 | Compliant | LF prefix | SnAgCu or SnCu | 240degC 10s |
| CFPS-303 | Compliant | LF prefix | SnAgCu or SnCu | 240degC 10s |
| CFPS-31 | Compliant | LF prefix | NiAu | 260degC 10s |
| CFPS-32 | Compliant | LF prefix | NiAu | 260degC 10s |
| CFPS-34 | Compliant | LF prefix | NiAu | 260degC 10s |
| CFPS-36 | Compliant | LF prefix | NiAu | 260degC 10s |

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| Product Range | RoHS Status | Part No. Status | Termination when compliant | Maximum reflow temperature and time |
|---------------|-------------|-----------------|----------------------------|-------------------------------------|
| CFPS-37 | Compliant | LF prefix | NiAu | 260degC 10s |
| CFPS-39 | Compliant | LF prefix | NiAu | 260degC 10s |
| CFPS-55 | Compliant | LF prefix | NiAu | 260degC 10s |
| CFPS-60 | Compliant | LF prefix | NiAu | 260degC 10s |
| CFPS-63 | Compliant | LF prefix | NiAu | 260degC 10s |
| CFPS-64 | Compliant | LF prefix | NiAu | 260degC 10s |
| CFPS-67 | Compliant | LF prefix | NiAu | 260degC 10s |
| CFPS-68 | Compliant | LF prefix | NiAu | 260degC 10s |
| CFPS-69 | Compliant | LF prefix | NiAu | 260degC 10s |
| CFPS-72 | Compliant | LF prefix | NiAu | 260degC 10s |
| CFPS-73 | Compliant | LF prefix | NiAu | 260degC 10s |
| CFPS-74 | Compliant | LF prefix | Au over Ni on W base | 260°C max for 10secs max |
| CFPS-9 | Compliant | LF prefix | NiAu | 260degC 10s |
| IQXO-149 | Compliant | LF prefix | SnAgCu or SnCu | 240degC 10s |
| IQXO-22 | Compliant | LF prefix | SnAgCu or SnCu | 240degC 10s |
| IQXO-23 | Compliant | LF prefix | SnAgCu or SnCu | 240degC 10s |
| IQXO-336 | Compliant | LF prefix | SnCu | 240degC 10s |
| IQXO-35 | Compliant | LF prefix | SnCu | 240degC 10s |
| IQXO-350 | Compliant | LF prefix | SnAgCu or SnCu | 235degC 10s |
| IQXO-36 | Compliant | LF prefix | SnCu | 240degC 10s |
| IQXO-365 | Compliant | LF prefix | SnCu | 240degC 10s |
| IQXO-430 | Compliant | LF prefix | Au over Ni, W base | 260°C max for 10secs max |
| IQXO-431 | Compliant | LF prefix | Au over Ni, W base | 260°C max for 10secs max |
| IQXO-432 | Compliant | LF prefix | Au over Ni, W base | 260°C max for 10secs max |
| IQXO-445 | Compliant | LF prefix | Au over Ni, W base | 260°C max for 10secs max |
| IQXO-446 | Compliant | LF prefix | Au over Ni, W base | 260°C max for 10secs max |
| IQXO-447 | Compliant | LF prefix | Au over Ni, W base | 260°C max for 10secs max |
| IQXO-628 | Compliant | LF prefix | NiAu | 240degC 10s |
| IQXO-70 | Compliant | LF prefix | NiAu | 260degC 10s |
| IQXO-71 | Compliant | LF prefix | NiAu | 260degC 10s |
| SSXO | | | | |
| CFSS-2 | Compliant | LF prefix | NiAu | 260degC 10s |
| CFSS-3 | Compliant | LF prefix | NiAu | 260degC 10s |
| TCXO | | | | |
| CFPT-127 | Compliant | LF prefix | NiCoAu | 260degC 10s |
| CFPT-37 | Compliant | LF prefix | NiCoAu | 260degC 10s |
| TVXO | | | | |

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|----------------|-------------|-----------------|----------------------------|-------------------------------------|
| CFPT-123 | Compliant | LF prefix | NiAu | 260degC 10s |
| CFPT-125 | Compliant | LF prefix | NiCoAu | 260degC 30s |
| CFPT-126 | Compliant | LF prefix | NiCoAu | 260degC 10s |
| CFPT-141 | Compliant | LF prefix | NiAu | 260degC 10s |
| VCXO | | | | |
| CFPV-115 | Compliant | LF prefix | NiAu | 260degC 10s |
| CFPV-32 | Compliant | LF prefix | NiAu | 260degC 10s |
| CFPV-41 | Compliant | LF prefix | NiAu | 260degC 10s |
| CFPV-42 | Compliant | LF prefix | NiAu | 260degC 10s |
| CFPV-43 | Compliant | LF prefix | NiAu | 260degC 10s |
| CFPV-44 | Compliant | LF prefix | NiAu | 260degC 10s |
| CFPV-45 | Compliant | LF prefix | NiAu | 260degC 10s |
| CFPV-46 | Compliant | LF prefix | NiAu | 260degC 10s |
| CFPV-55 | Compliant | LF prefix | NiAu | 260degC 10s |
| IQVCXO-161 | Compliant | LF prefix | SnCuNi | 260degC 10s |
| XTAL(Q) | | | | |
| 12SMX | Compliant | LF prefix | NiAu | 260degC 10s |
| 14SMX | Compliant | LF prefix | NiAu | 260degC 10s |
| 3SMX | Compliant | LF prefix | NiAu | 260degC 10s |
| 4SMX | Compliant | LF prefix | NiAu | 260degC 10s |
| 6SMX | Compliant | LF prefix | NiAu | 260degC 10s |
| 86SMX | Compliant | LF prefix | SnCu | 260degC 10s |
| 87SMX | Compliant | LF prefix | SnAgCu | 260degC 10s |
| CFPX-180 | Compliant | LF prefix | NiAu | 260degC 10s |
| CFPX-181 | Compliant | LF prefix | NiAu | 260degC 10s |
| CFPX-201 | Compliant | LF prefix | NiAu | 260degC 10s |
| CFPX-218 | Compliant | LF prefix | NiAu | 260°C max for 10secs max |
| CFPX-225 | Compliant | LF prefix | NiAu | 260degC 10s |
| CFPX-228 | Compliant | LF prefix | NiAu | 260degC 10s |
| CFPX-98 | Compliant | LF prefix | CuSnNiP or Sn | 260degC 10s |
| HC49 | Compliant | LF prefix | SnAgCu or Sn | 260degC 10s |
| HC49/4H | Compliant | LF prefix | SnAgCu or Sn | 260degC 10s |
| HC49/4HSMX | Compliant | LF prefix | SnAgCu or Sn | 260degC 10s |
| IQXC-42 | Compliant | LF prefix | NiAu | 260degC 10s |
| XTAL(W) | | | | |
| 85SMX | Compliant | LF prefix | Matte Sn | 260degC 10s |
| 90SMX | Compliant | LF prefix | Matte Sn | 260degC 10s |

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|---------------|-------------|-----------------|----------------------------|-------------------------------------|
| 91SMX | Compliant | LF prefix | Matte Sn | 260degC 10s |
| CFPX-155 | Compliant | LF prefix | Matte Sn | 260degC 10s |
| CFPX-217 | Compliant | LF prefix | SnAu | 260degC 10s |
| CFPX-56 | Compliant | LF prefix | SnAgCu | 230degC 10s |

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